IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
upplier Informa	ation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi											2024-05-01				
Contact Name			Title - Contact			I	Phone - Contact*					Email - Contact*			
Product-Env-Stewar	rds		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Requester	equester Item Number Mfr Item		m Number Mfr Item Name				Effective Date	Vers	sion Manufacturing Site		ring Site		Weight*	UOM	Unit Type
		MJF44H11G BIP T0220F		BIP T0220FP NPN	P NPN 10A 60V		2024-05-01			KR8		:	1436.68	mg	Each
	Process Information				GED 020 Mg	I D d	D 1 D	D		) ( m		T		CD C	,
3 · · · · · · · · · · · · · · · · · · ·					-STD-020 MS	L Rating		Process Body Temperature   Max Time at Peak		<u> </u>			cles		
•	(Sn) - annealed	C	CU Alloy	IN	NA .		0		JC	30		secon	ds   3		
omments															
r more informatio	n regarding material co	omposition ]	please refer to	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and cornel to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-6_									

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	8.32	mg	Supplier	Silicon (Si)	7440-21-3		8.32	mg
Die Attach	13.08	mg	A	Lead (Pb)	7439-92-1	7a	12.426	mg
			Supplier	Tin (Sn)	7440-31-5		0.654	mg
Lead Frame	498.3	mg	Supplier	Copper (Cu)	7440-50-8		498.3	mg
Mold Compound-Black	897.4	mg		Phenolic Resin	proprietary data		44.87	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		67.305	mg
			Supplier	Carbon Black (C)	1333-86-4		4.487	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		197.428	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		583.31	mg
Plating	12.24	mg	Supplier	Tin (Sn)	7440-31-5		12.24	mg
Wire Bond - Al	7.34	mg	Supplier	Aluminum (Al)	7429-90-5		7.34	mg